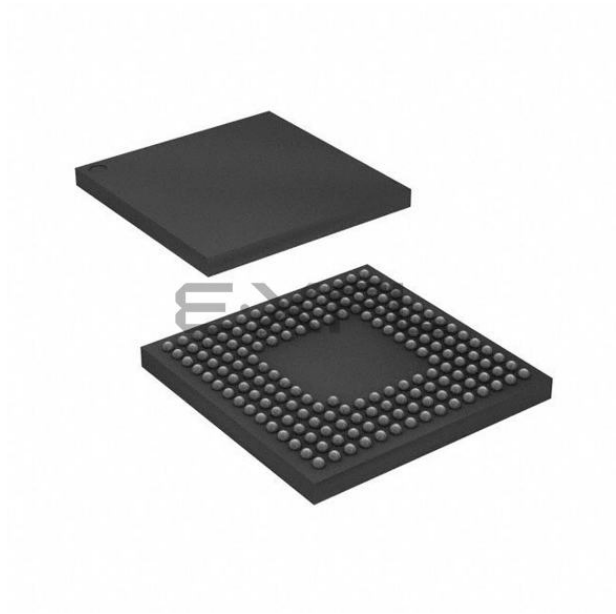
Renesas Electronics America Inc - R5F56317CDLC#U0 Datasheet



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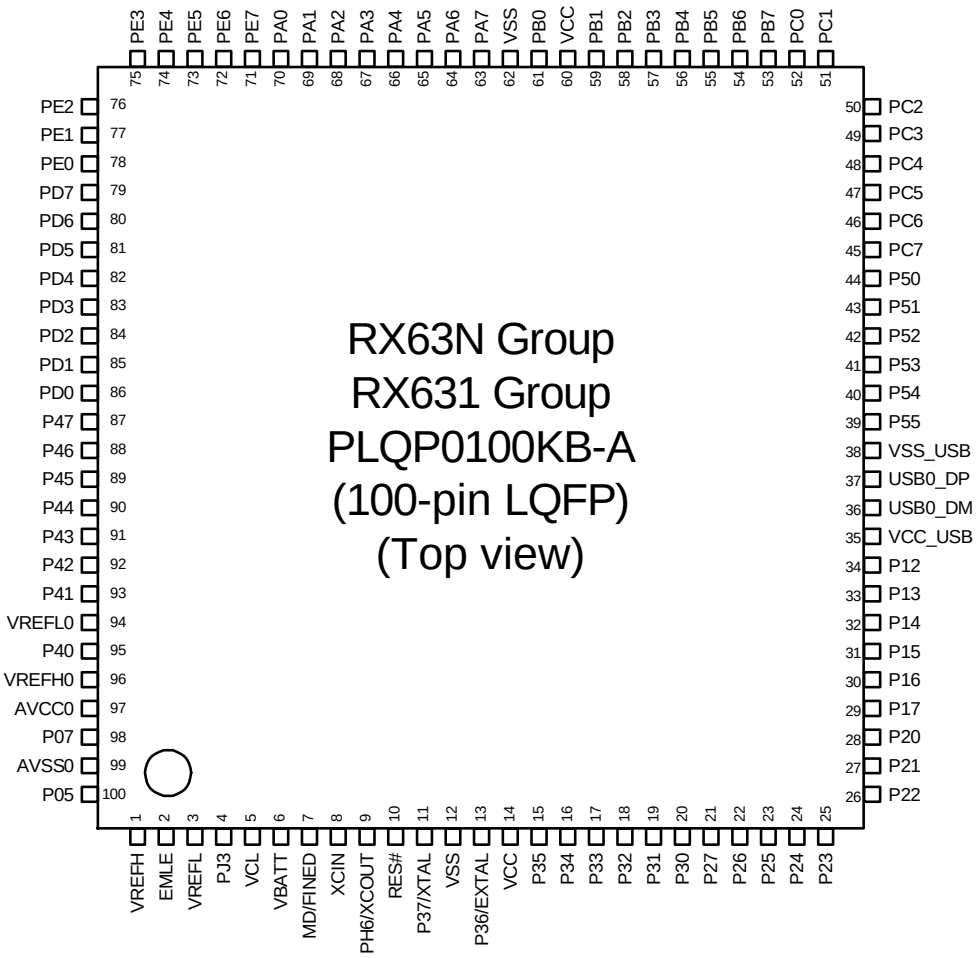
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	133
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	177-TFLGA
Supplier Device Package	177-TFLGA (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f56317cdlc-u0

Table 1.1 Outline of Specifications (5/6)

Classification	Module/Function	Description
Communication function	Ethernet controller (ETHERC)	• Input and output of Ethernet/IEEE 802.3 frames • Transfer at 10 or 100 Mbps • Full- and half-duplex modes • MII (Media Independent Interface) or RMII (Reduced Media Independent Interface) as defined in IEEE 802.3u • Detection of Magic Packets™*1 or output of a "wake-on-LAN" signal (WOL) • Compliance with flow control as defined in IEEE 802.3x standards Note 1. Magic PacketTM is a registered trademark of Advanced Micro Devices, Inc.
	DMA controller for Ethernet controller (EDMAC)	• Alleviation of CPU loads by the descriptor control method • Transmission FIFO: 2 Kbytes; Reception FIFO: 2 Kbytes
	USB 2.0 host/function module (USBa)	• Includes a UDC (USB Device Controller) and transceiver for USB 2.0 • Host/function module: one port, function module: one port • Compliance with the USB 2.0 specification • Transfer rate: Full speed (12 Mbps) • Self-power mode and bus-power mode are selectable • OTG (On the Go) operation is possible • Incorporates 2 Kbytes of RAM as a transfer buffer
	Serial communications interfaces (SCIc, SCId)	• 13 channels (SCIc: 12 channels + SCId: 1 channel) • SCIc Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12 Simple I^2C Simple SPI • SCId (The following functions are added to SCIc) Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format
	I^2C bus interfaces (RIIC)	• 4 channels (one of them is FM+) • Communication formats I^2C bus format/SMBus format Supports the multi-master Max. transfer rate: 1 Mbps (channel 0)
	IEBus (IEB)	• 1 channel • Supports protocol control for the IEBus Half-duplex asynchronous transfer Multi-master operation Broadcast communications function Two selectable modes, differentiated by transfer rate
	CAN module (CAN)	• 3 channels • Compliance with the ISO11898-1 specification (standard frame and extended frame) • 32 mailboxes each
	Serial peripheral interfaces (SPI)	• 3 channels • RSPI transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave • Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Buffered structure Double buffers for both transmission and reception



Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.10, List of Pins and Pin Functions (100-Pin LQFP).

Figure 1.9 Pin Assignment (100-Pin LQFP)

RX631 Group
PTLG0064JA-A (64-pin TFLGA)
(Top perspective view)

	A	B	C	D	E	F	G	H	
8	PE3	PE4	PA0	PA3	PB0	PB3	PB6	PB7	8
7	PE2	PE1	PE5	PA1	VSS	PB5	PC3	PC2	7
6	VREFL	P46	PE0	PA4	VCC	PB1	PC6	USB1_DP	6
5	VREFH	P44	P43	PA6	PC4	P15	VCC_USB	USB1_DM	5
4	VREFL0	P42	P41	P14	P16	PC5	VSS_USB	USB0_DP	4
3	VREFH0	P40	EMLE	P27	P30	P31	VCC_USB	USB0_DM	3
2	AVCC0	AVSS0	MD/FINED	RES#	VBATT	P35	P26	P17	2
1	P05	VCL	XCIN	XCOUT	VSS	VCC	EXTAL	XTAL	1
	A	B	C	D	E	F	G	H	

Figure 1.10 Pin Assignment (64-pin TFLGA)

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (3/5)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
H3	RES#						
H4		P35				NMI	
H12		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	ET_MDC/TXD5/SMOSI5/ SSDA5/SSLA0	IRQ5-DS	
H13		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	ET_MDIO/RXD5/SMISO5/ SSCL5	IRQ6-DS	
H14		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
H15	TRDATA3	PG7	D31				
J1	EXTAL	P36					
J2	VCC						
J3		P34		MTIOC0A/TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
J4	TMS	PF3					
J12		PA5	A5	TIOCB1/PO21	ET_LINKSTA/RSPCKA		
J13	VSS						
J14		PA7	A7	TIOCB2/PO23	ET_WOL/MISOA		
J15		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	ET_EXOUT/CTS5#/ RTS5#/SS5#/MOSIA		
K1		P33		MTIOC0D/TIOCD0/ TMRI3/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/SSCL0/ CRX0/PCKO	IRQ3-DS	
K2		P32		MTIOC0C/TIOCC0/TMO3/ PO10/RTCOUT/RTCIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/SSDA0/ CTX0/USB0_VBUSEN/ VSYNC	IRQ2-DS	
K3	TDI	PF2			RXD1/SMISO1/SSCL1		
K4	TCK/FINEC	PF1			SCK1		
K12		PB2	A10	TIOCC3/TCLKC/PO26	ET_RX_CLK/REF50CK/ CTS4#/RTS4#/CTS6#/ RTS6#/SS4#/SS6#		
K13		P71	CS1#		ET_MDIO		
K14	VCC						
K15		PB0	A8	MTIC5W/TIOCA3/PO24	ET_ERXD1/RMII_RXD1/ RXD4/RXD6/SMISO4/ SMISO6/SSCL4/SSCL6/ RSPCKA	IRQ12	
L1		P31		MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
L2		P30		MTIOC4B/TMRI3/PO8/ RTCIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
L3	TDO	PF0			TXD1/SMOSI1/SSDA1		
L4		P25	CS5#/EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3/ USB0_DPRPD/HSYNC		ADTRG0#
L12		PB6	A14	MTIOC3D/TIOCA5/PO30	ET_ETXD1/RMII_TXD1/ RXD9/SMISO9/SSCL9		
L13		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	ET_RX_ER/RMII_RX_ER/ SCK4/SCK6		
L14		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	ET_ERXD0/RMII_RXD0/ TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/SSDA6	IRQ4-DS	
L15		P72	CS2#		ET_MDC		
M1		P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (4/5)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
M2		P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3# SMOSI1/SS3#/SSDA1/ MOSIB		
M3		P24	CS4#/EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/USB0_VBUSEN/ PIXCLK		
M4		P86		TIOCA0	PIXD1		
M5		P13		MTIOC0B/TIOCA5/TMO3/ PO13	TXD2/SMOSI2/SSDA2/ SDA0[FM+]	IRQ3	ADTRG#
M6		P56	WR2#/BC2#/ EDACK1	MTIOC3C/TIOCA1			
M7		P54	ALE/EDACK0	MTIOC4B/TMCI1	ET_LINKSTA/CTS2#/ RTS2#/SS2#/CTX1		
M8		P53*2	BCLK				
M9		P50	WR0#/WR#		TXD2/SMOSI2/SSDA2/ SSLB1		
M10		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/ TIOCD6/TCLKF/TMRI2/ PO29	ET_ETXD2/SCK8/ RSPCKA		
M11		P81	EDACK0	MTIOC3D/PO27	ET_ETXD0/RMII_TXD0/ RXD10/SMISO10/SSCL10		
M12		P77	CS7#	PO23	ET_RX_ER/RMII_RX_ER/ TXD11/SMOSI11/SSDA11		
M13		PB7	A15	MTIOC3B/TIOCB5/PO31	ET_CRS/RMII_CRS_DV/ TXD9/SMOSI9/SSDA9		
M14		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	ET_ETXD0/RMII_TXD0/ SCK9		
M15		PB4	A12	TIOCA4/PO28	ET_TX_EN/ RMII_TXD_EN/CTS9#/ RTS9#/SS9#		
N1	VCC						
N2		P23	EDACK0	MTIOC3D/MTCLKD/ TIOCD3/PO3	TXD3/CTS0#/RTS0#/ SMOSI3/SS0#/SSDA3/ USB0_DPUPE/PIXD7		
N3		P22	EDREQ0	MTIOC3B/MTCLKC/ TIOCC3/TMO0/PO2	SCK0/USB0_DRPD/ PIXD6		
N4		P15		MTIOC0B/MTCLKB/ TIOCB2/TCLKB/TMCI2/ PO13	RXD1/SCK3/SMISO1/ SSCL1/CRX1-DS/ USB1_DPUPE/PIXD0	IRQ5	
N5		P12		MTIC5U/TMCI1	RXD2/SMISO2/SSCL2/ SCL0[FM+]	IRQ2	
N6		P57	WAIT#/WR3#/ BC3#/EDREQ1				
N7		P55	WAIT#/ EDREQ0	MTIOC4D/TMO3	ET_EXOUT/CRX1	IRQ10	
N8	VCC_USB						
N9		P51	WR1#/BC1#/ WAIT#		SCK2/SSLB2		
N10		PC7	A23/CS0#	MTIOC3A/MTCLKB/ TIOCB6/TMO2/PO31	ET_COL/TXD8/SMOSI8/ SSDA8/MISOA	IRQ14	
N11		P82	EDREQ1	MTIOC4A/PO28	ET_ETXD1/RMII_TXD1/ TXD10/SMOSI10/SSDA10		
N12		PC3	A19	MTIOC4D/TCLKB/PO24	ET_TX_ER/TXD5/ SMOSI5/SSDA5/IETXD		
N13		PC0	A16	MTIOC3C/TCLKC/PO17	ET_ERXD3/CTS5#/ RTS5#/SS5#/SSLA1/ SCL3	IRQ14	
N14		P73	CS3#	PO16	ET_WOL		
N15	VSS						

Table 1.6 List of Pin and Pin Functions (176-Pin LQFP) (1/5)

Pin Number 176-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
1	AVSS0						
2		P05				IRQ13	DA1
3	VREFH						
4		P03				IRQ11	DA0
5	VREFL						
6		P02		TMCI1	SCK6	IRQ10	AN020
7		P01		TMCI0	RXD6/SMISO6/SSCL6	IRQ9	AN019
8		P00		TMRI0	TXD6/SMOSI6/SSDA6	IRQ8	AN018
9		PF5				IRQ4	
10	EMLE						
11		PJ5					
12	VSS						
13		PJ3		MTIOC3C	CTS6#/RTS6#/CTS0#/ RTS0#/SS6#/SS0#		
14	VCL						
15	VBATT						
16	NC						
17	TRST#	PF4					
18	MD/FINED						
19	XCIN						
20	XCOUT						
21	RES#						
22	XTAL	P37					
23	VSS						
24	EXTAL	P36					
25	VCC						
26		P35				NMI	
27		P34		MTIOC0A/TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
28		P33		MTIOC0D/TIOCD0/ TMRI3/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/SSCL0/ CRX0/PCKO	IRQ3-DS	
29		P32		MTIOC0C/TIOCC0/TMO3/ PO10/RTCOUT/RTCIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/SSDA0/ CTX0/USB0_VBUSEN/ VSYNC	IRQ2-DS	
30	TMS	PF3					
31	TDI	PF2			RXD1/SMISO1/SSCL1		
32		P31		MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
33		P30		MTIOC4B/TMRI3/PO8/ RTCIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
34	TCK/FINEC	PF1			SCK1		
35	TDO	PF0			TXD1/SMOSI1/SSDA1		
36		P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		
37		P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3# SMOSI1/SS3#/SSDA1/ MOSIB		
38		P25	CS5#/EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3/ USB0_DPRPD/HSYNC		ADTRG0#
39	VCC						
40		P24	CS4#/EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/USB0_VBUSEN/ PIXCLK		

Table 1.8 List of Pins and Pin Functions (144-Pin LQFP) (4/5)

Pin No. 144-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
89		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5# MOSIA/ET_EXOUT		
90		PA5	A5	TIOCB1/PO21	RSPCKA/ET_LINKSTA		
91	VCC						
92		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0/ET_MDC	IRQ5-DS	
93	VSS						
94		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5/ ET_MDIO	IRQ6-DS	
95		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
96		PA1	A1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/ET_WOL	IRQ11	
97		PA0	A0/BC0#	MTIOC4A/TIOCA0/ PO16	SSLA1/ET_TX_EN/ RMII_TXD_EN		
98		P67	CS7#/DQM1		CRX2*2	IRQ15	
99		P66	CS6#/DQM0		CTX2*2		
100		P65	CS5#/CKE				
101		PE7	D15[A15/D15]	TIOCB11	MISOB	IRQ7	AN5
102		PE6	D14[A14/D14]	TIOCA11	MOSIB	IRQ6	AN4
103	VCC						
104	SDCLK	P70					
105	VSS						
106		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ TIOCB10	RSPCKB/ET_RX_CLK/ REF50CK	IRQ5	AN3
107		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ TIOCA10/PO28	SSLB0/ET_ERXD2		AN2
108		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/ PO26/POE8#	CTS12#/RTS12#/ SS12#/MISOB/ ET_ERXD3		AN1
109		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/ PO23	RXD12/SMISO12/ SSCL12/RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN0
110		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/ PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/ RSPCKB		ANEX1
111		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0
112		P64	CS4#/WE#				
113		P63	CS3#/CAS#				
114		P62	CS2#/RAS#				
115		P61	CS1#/SDCS#				
116	VSS						
117		P60	CS0#				
118	VCC						
119		PD7	D7[A7/D7]	MTIC5U/POE0#	SSLC3	IRQ7	AN7
120		PD6	D6[A6/D6]	MTIC5V/POE1#	SSLC2	IRQ6	AN6
121		PD5	D5[A5/D5]	MTIC5W/POE2#	SSLC1	IRQ5	AN013
122		PD4	D4[A4/D4]	POE3#	SSLC0	IRQ4	AN012
123		PD3	D3[A3/D3]	TIOCB8/TCLKH/ POE8#	RSPCKC	IRQ3	AN011
124		PD2	D2[A2/D2]	MTIOC4D/TIOCA8	MISOC/CRX0	IRQ2	AN010

Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (2/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
D2	XCOUT						
D3	MD/FINED						
D4	VBATT						
D5		P45				IRQ13-DS	AN005
D6		P46				IRQ14-DS	AN006
D7		PE6	D14[A14/D14]		MOSIB	IRQ6	AN4
D8		PE7	D15[A15/D15]		MISOB	IRQ7	AN5
D9		PA1	A1	MTIOC0B/ MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/ ET_WOL	IRQ11	
D10		PA0	A0/BC0#	MTIOC4A/ TIOCA0/PO16	SSLA1/ET_TX_EN/ RMII_TXD_EN		
E1	XTAL	P37					
E2	VSS						
E3	RES#						
E4	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
E5		P41				IRQ9-DS	AN001
E6		PA2	A2	PO18	RXD5/SMISO5/ SSCL5/SSLA3		
E7		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE2#	CTS5#/RTS5#/ SS5#/MOSIA/ ET_EXOUT		
E8		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20	TXD5/SMOSI5/ SSDA5/SSLA0/ ET_MDC	IRQ5-DS	
E9		PA5	A5	TIOCB1/PO21	RSPCKA/ ET_LINKSTA		
E10		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19	RXD5/SMISO5/ SSCL5/ET_MDIO	IRQ6-DS	
F1	EXTAL	P36					
F2	VCC						
F3		P35				NMI	
F4		P32		MTIOC0C/ TIOCC0/TMO3/ PO10/ RTCOUT/ RTCIC2	TXD6/TXD0/ SMOSI6/SMOSI0/ SSDA6/SSDA0/ CTX0*1/ USB0_VBUSEN	IRQ2-DS	
F5		P12		TMCI1	RXD2/SMISO2/ SSCL2/SCL0[FM+]	IRQ2	
F6		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE3#	SCK6/ET_RX_ER/ RMII_RX_ER		

Table 4.1 List of I/O Registers (Address Order) (3/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 2818h	EXDMAC0	EXDMA offset register	EDMOFR	32	32	1, 2 BCLK		EXDMACa
0008 281Ch	EXDMAC0	EXDMA transfer enable register	EDMCNT	8	8	1, 2 BCLK		
0008 281Dh	EXDMAC0	EXDMA software start register	EDMREQ	8	8	1, 2 BCLK		
0008 281Eh	EXDMAC0	EXDMA status register	EDMSTS	8	8	1, 2 BCLK		
0008 2820h	EXDMAC0	EXDMA external request sense mode register	EDMRMD	8	8	1, 2 BCLK		
0008 2821h	EXDMAC0	EXDMA external request flag register	EDMERF	8	8	1, 2 BCLK		
0008 2822h	EXDMAC0	EXDMA peripheral request flag register	EDMPRF	8	8	1, 2 BCLK		
0008 2840h	EXDMAC1	EXDMA source address register	EDMSAR	32	32	1, 2 BCLK		
0008 2844h	EXDMAC1	EXDMA destination address register	EDMDAR	32	32	1, 2 BCLK		
0008 2848h	EXDMAC1	EXDMA transfer count register	EDMCRA	32	32	1, 2 BCLK		
0008 284Ch	EXDMAC1	EXDMA block transfer count register	EDMCRB	16	16	1, 2 BCLK		
0008 2850h	EXDMAC1	EXDMA transfer mode register	EDMTMD	16	16	1, 2 BCLK		
0008 2852h	EXDMAC1	EXDMA output setting register	EDMOMD	8	8	1, 2 BCLK		
0008 2853h	EXDMAC1	EXDMA interrupt setting register	EDMINT	8	8	1, 2 BCLK		
0008 2854h	EXDMAC1	EXDMA address mode register	EDMAMD	32	32	1, 2 BCLK		
0008 285Ch	EXDMAC1	EXDMA transfer enable register	EDMCNT	8	8	1, 2 BCLK		
0008 285Dh	EXDMAC1	EXDMA software start register	EDMREQ	8	8	1, 2 BCLK		
0008 285Eh	EXDMAC1	EXDMA status register	EDMSTS	8	8	1, 2 BCLK		
0008 2860h	EXDMAC1	EXDMA external request sense mode register	EDMRMD	8	8	1, 2 BCLK		
0008 2861h	EXDMAC1	EXDMA external request flag register	EDMERF	8	8	1, 2 BCLK		
0008 2862h	EXDMAC1	EXDMA peripheral request flag register	EDMPRF	8	8	1, 2 BCLK		
0008 2A00h	EXDMAC	EXDMA module start register	EDMAST	8	8	1, 2 BCLK		
0008 2BE0h	EXDMAC	Cluster buffer register 0	CLSBR0	32	32	1, 2 BCLK		
0008 2BE4h	EXDMAC	Cluster buffer register 1	CLSBR1	32	32	1, 2 BCLK		
0008 2BE8h	EXDMAC	Cluster buffer register 2	CLSBR2	32	32	1, 2 BCLK		
0008 2BECh	EXDMAC	Cluster buffer register 3	CLSBR3	32	32	1, 2 BCLK		
0008 2BF0h	EXDMAC	Cluster buffer register 4	CLSBR4	32	32	1, 2 BCLK		
0008 2BF4h	EXDMAC	Cluster buffer register 5	CLSBR5	32	32	1, 2 BCLK		
0008 2BF8h	EXDMAC	Cluster buffer register 6	CLSBR6	32	32	1, 2 BCLK		
0008 2BFCh	EXDMAC	Cluster buffer register 7	CLSBR7	32	32	1, 2 BCLK		
0008 3002h	BSC	CS0 mode register	CS0MOD	16	16	1, 2 BCLK		Buses
0008 3004h	BSC	CS0 wait control register 1	CS0WCR1	32	32	1, 2 BCLK		
0008 3008h	BSC	CS0 wait control register 2	CS0WCR2	32	32	1, 2 BCLK		
0008 3012h	BSC	CS1 mode register	CS1MOD	16	16	1, 2 BCLK		
0008 3014h	BSC	CS1 wait control register 1	CS1WCR1	32	32	1, 2 BCLK		
0008 3018h	BSC	CS1 wait control register 2	CS1WCR2	32	32	1, 2 BCLK		
0008 3022h	BSC	CS2 mode register	CS2MOD	16	16	1, 2 BCLK		
0008 3024h	BSC	CS2 wait control register 1	CS2WCR1	32	32	1, 2 BCLK		
0008 3028h	BSC	CS2 wait control register 2	CS2WCR2	32	32	1, 2 BCLK		
0008 3032h	BSC	CS3 mode register	CS3MOD	16	16	1, 2 BCLK		
0008 3034h	BSC	CS3 wait control register 1	CS3WCR1	32	32	1, 2 BCLK		
0008 3038h	BSC	CS3 wait control register 2	CS3WCR2	32	32	1, 2 BCLK		
0008 3042h	BSC	CS4 mode register	CS4MOD	16	16	1, 2 BCLK		
0008 3044h	BSC	CS4 wait control register 1	CS4WCR1	32	32	1, 2 BCLK		
0008 3048h	BSC	CS4 wait control register 2	CS4WCR2	32	32	1, 2 BCLK		
0008 3052h	BSC	CS5 mode register	CS5MOD	16	16	1, 2 BCLK		
0008 3054h	BSC	CS5 wait control register 1	CS5WCR1	32	32	1, 2 BCLK		
0008 3058h	BSC	CS5 wait control register 2	CS5WCR2	32	32	1, 2 BCLK		
0008 3062h	BSC	CS6 mode register	CS6MOD	16	16	1, 2 BCLK		
0008 3064h	BSC	CS6 wait control register 1	CS6WCR1	32	32	1, 2 BCLK		
0008 3068h	BSC	CS6 wait control register 2	CS6WCR2	32	32	1, 2 BCLK		

Table 4.1 List of I/O Registers (Address Order) (45/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
000A 024Eh	USB1	Device state changing register	DVCHGR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0250h	USB1	USB address register	USBADDR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0254h	USB1	USB request type register	USBREQ	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0256h	USB1	USB request value register	USBVAL	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0258h	USB1	USB request index register	USBINDX	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 025Ah	USB1	USB request length register	USBLENG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	USBa
000A 025Ch	USB1	DCP configuration register	DCPCFG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 025Eh	USB1	DCP maximum packet size register	DCPMAXP	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0260h	USB1	DCP control register	DCPCTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0264h	USB1	Pipe window select register	PIPESEL	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	

Table 5.3 DC Characteristics (2)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Output high voltage	All output pins	V_{OH}	VCC – 0.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins (except for RIIC pins, and ETHERC)	V_{OL}	—	—	0.5	V	I_{OL} = 1.0 mA
	RIIC pins		—	—	0.4	V	I_{OL} = 3.0 mA
			—	—	0.6		I_{OL} = 6.0 mA
	RIIC pins (only P12 and P13 in channel 0)	V_{OL}	—	—	0.4	V	I_{OL} = 15.0 mA (ICFER.FMPE = 1)
			—	0.4	—		I_{OL} = 20.0 mA (ICFER.FMPE = 1)
	ETHERC	V_{OL}	—	—	0.4	V	I_{OL} = 1.0 mA
Input leakage current	RES#, MD pin, EMLE*1, NMI	$\lvert I_{in} \rvert$	—	—	1.0	µA	V_{in} = 0 V V_{in} = VCC
Three-state leakage current (off state)	Other than ports for 5 V tolerant	$\lvert I_{TSI} \rvert$	—	—	1.0	µA	V_{in} = 0 V V_{in} = VCC
	Ports for 5 V tolerant		—	—	5.0		Vin = 0 V Vin = 5.5 V
Input pull-up MOS current	Ports 0 to 2, 30 to 34, 36, 37, 4 to G, J3, J5	I_p	–10	—	–300	µA	VCC= 2.7 to 3.6 V V_{in} = 0 V
Input capacitance	All input pins (except for ports 12, 13, 16, 17, 20, 21, 4, C0, C1, and EMLE)	C_{in}	—	—	15	pF	V_{in} = 0 V f = 1 MHz T_a = 25°C
	Ports 12, 13, 16, 17, 20, 21, 4, C0, C1, EMLE		—	—	30		
Input pull-down MOS current	EMLE, BSCANP	I_p	10	—	300	µA	V_{in} = VCC

Note 1. The input leakage current value at the EMLE pin is only when V_{in} = 0 V.

5.3 AC Characteristics

Table 5.8 Operation Frequency Value (High-Speed Operating Mode)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

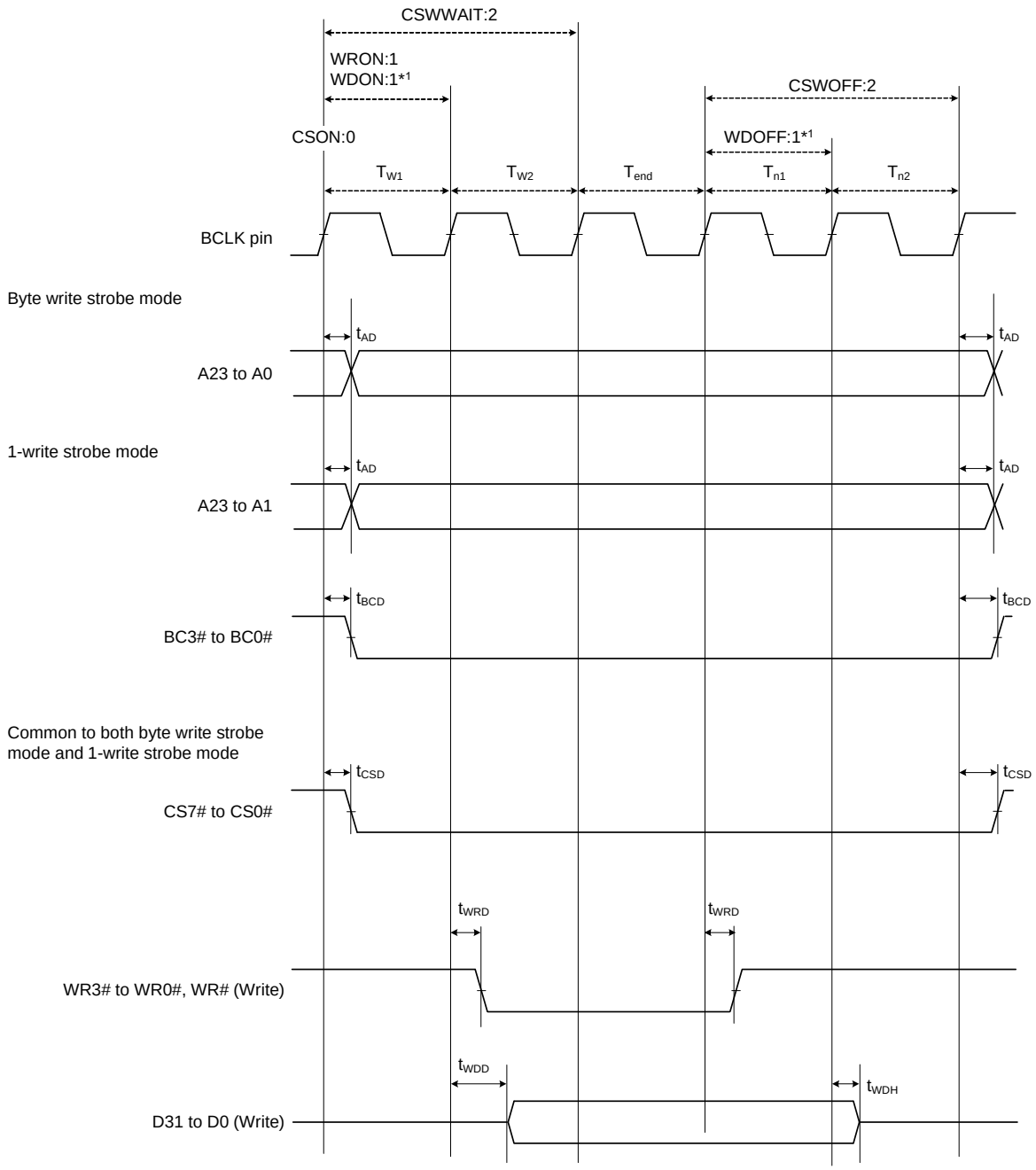
Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	—*1	—	100	MHz
	Peripheral module clock (PCLKA)			—*1	—	100	
	Peripheral module clock (PCLKB)			—*2	—	50	
	FlashIF clock (FCLK)			—*3	—	50	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	100	
		Packages with 100 pins or less		—	—	50	
	BCLK pin output	Packages with 177 to 144 pins		—	—	50	
		Packages with 100 pins or less		—	—	25	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	50	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	50	
	USB clock (UCLK)			—	—	48	
	IEBUS clock (IECLK)			—	—	44.03	

Note 1. The ICLK and PCLKA frequencies must be the same and at least 12.5 MHz if the Ethernet controller is in use
Note 2. The PCLKB must run at a frequency of at least 24 MHz if the USB is in use.
Note 3. The FCLK must run at a frequency of at least 4 MHz when changing the ROM or E2 DataFlash memory contents.

Table 5.9 Operation Frequency Value (Low-Speed Operating Mode 1)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	—	—	1	MHz
	Peripheral module clock (PCLKA)			—	—	1	
	Peripheral module clock (PCLKB)			—	—	1	
	FlashIF clock (FCLK)			—	—	1	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	1	
		Packages with 100 pins or less		—	—	1	
	BCLK pin output	Packages with 177 to 144 pins		—	—	1	
		Packages with 100 pins or less		—	—	1	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	1	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	1	
	USB clock (UCLK)			—	—	1	
	IEBUS clock (IECLK)			—	—	1	



Note1. Be sure to specify WDON and WDOFF as at least one cycle of BCLK.

Figure 5.20 External Bus Timing/Normal Write Cycle (Bus Clock Synchronized)

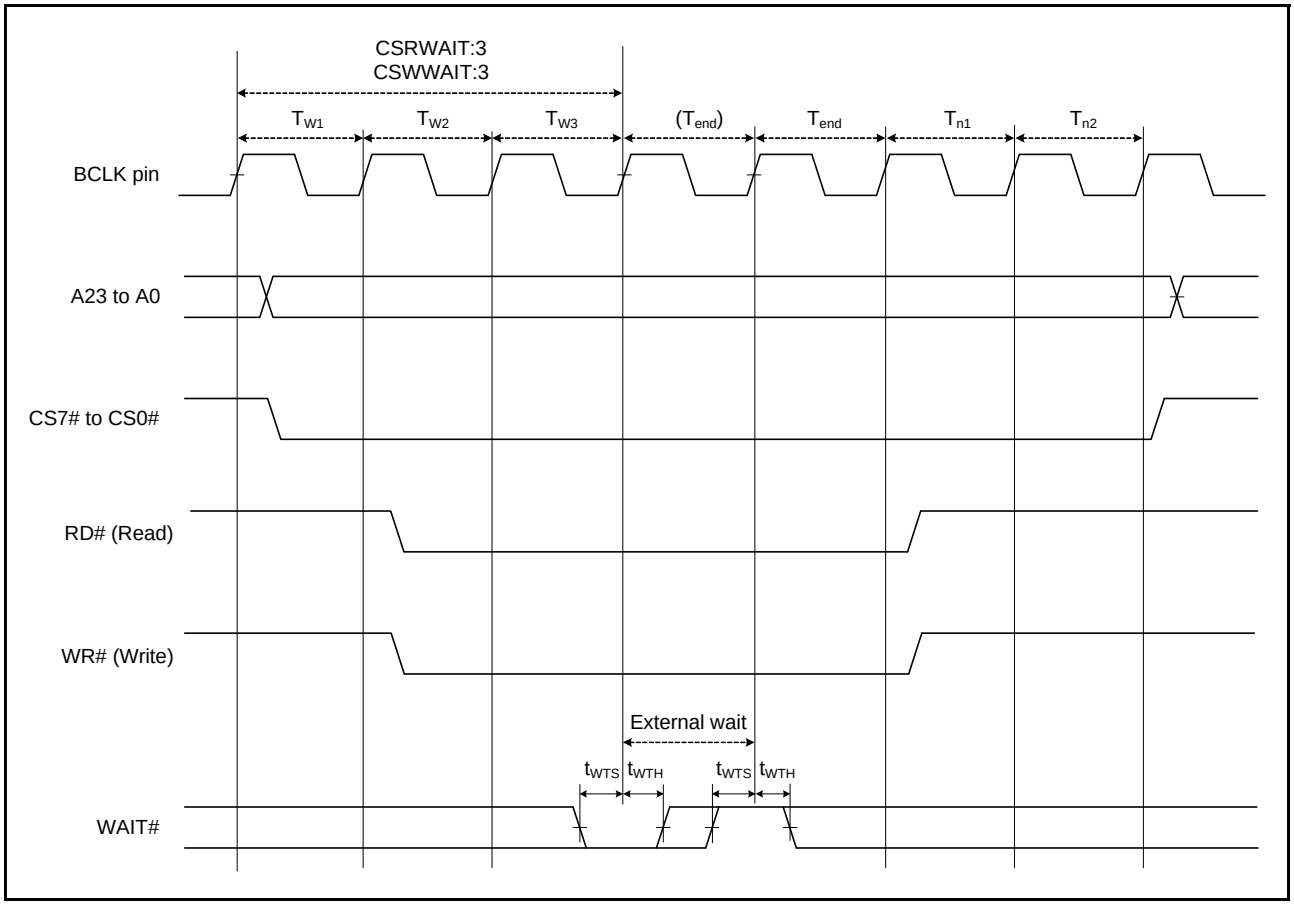
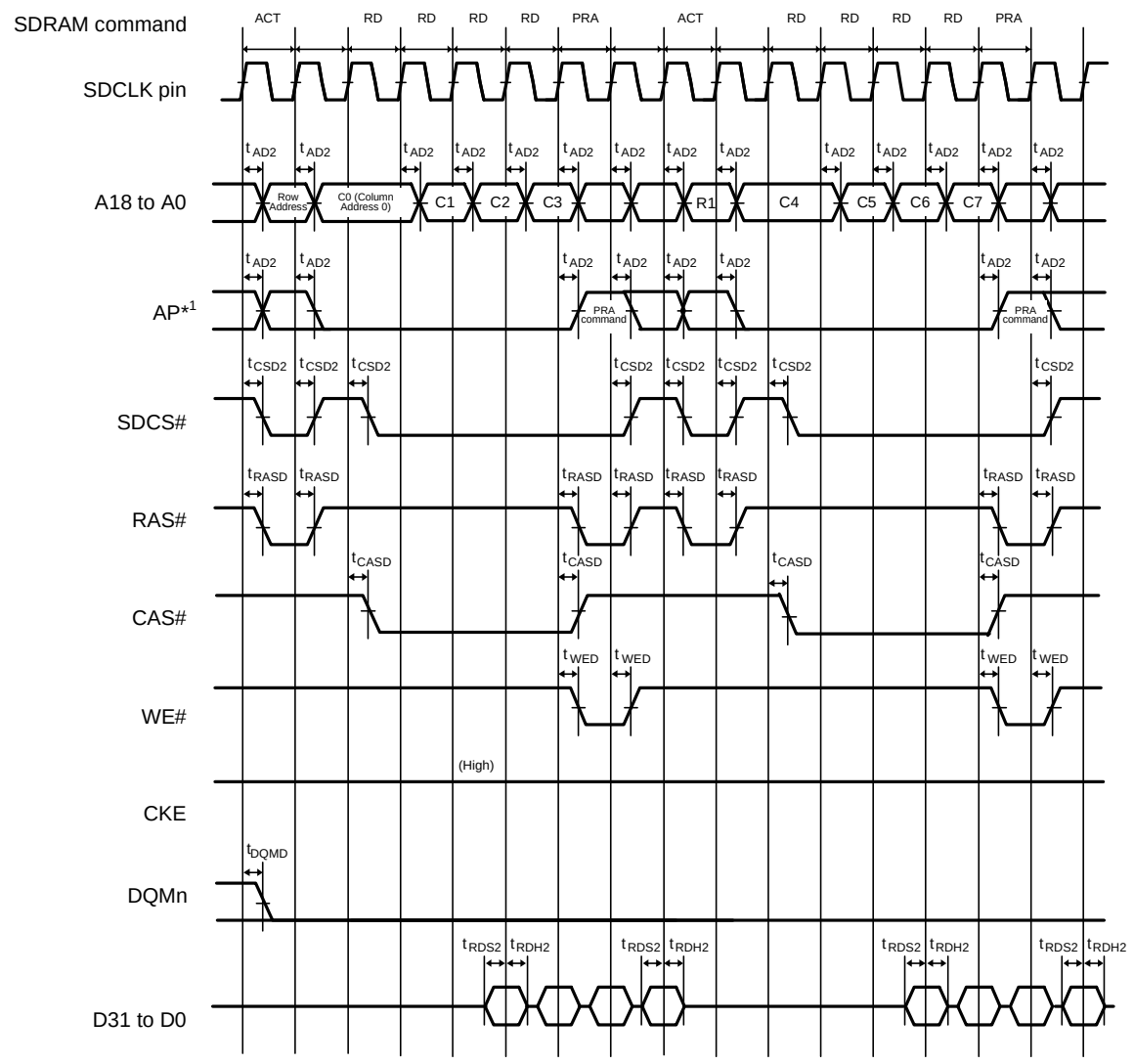
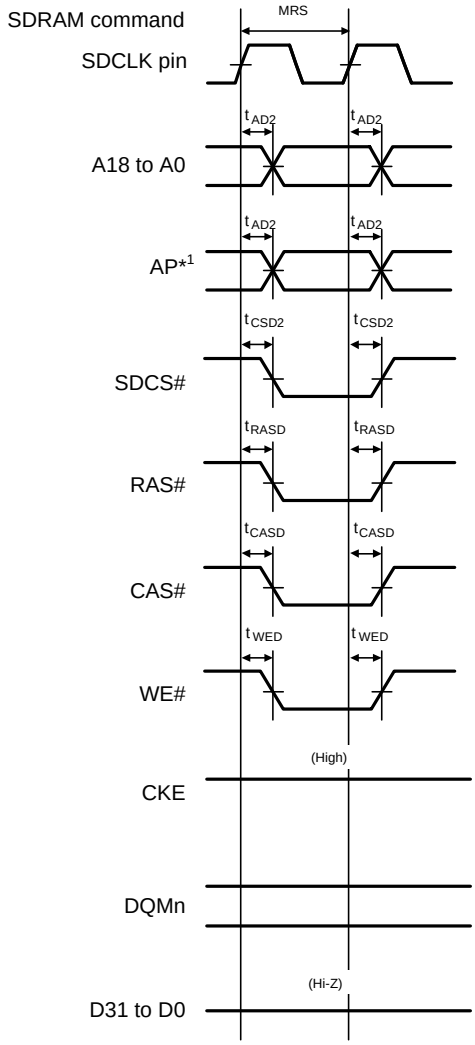


Figure 5.23 External Bus Timing/External Wait Control



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.28 SDRAM Space Multiple Read Line Stride Bus Timing



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.29 SDRAM Space Mode Register Set Bus Timing

Table 5.22 Timing of On-Chip Peripheral Modules (4)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
PCLK = 8 to 50 MHz
$T_a = T_{opr}$
High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)	t_{SPcyc}	4	65536	t_{Pcyc}	Figure 5.42
	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width	t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time	t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time	t_{SU}	40	—	ns	Figure 5.43 to Figure 5.46
	Data input hold time	t_H	40	—	ns	
	SS input setup time	t_{LEAD}	1	—	t_{SPcyc}	
	SS input hold time	t_{LAG}	1	—	t_{SPcyc}	
	Data output delay time	t_{OD}	—	40	ns	
	Data output hold time	t_{OH}	–10	—	ns	
	Data rise/fall time	t_{Dr}, t_{Df}	—	20	ns	
	SS input rise/fall time	t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time	t_{SA}	—	5	t_{Pcyc}	Figure 5.46
	Slave output release time	t_{REL}	—	5	t_{Pcyc}	

Note 1. t_{Pcyc}: PCLK cycle

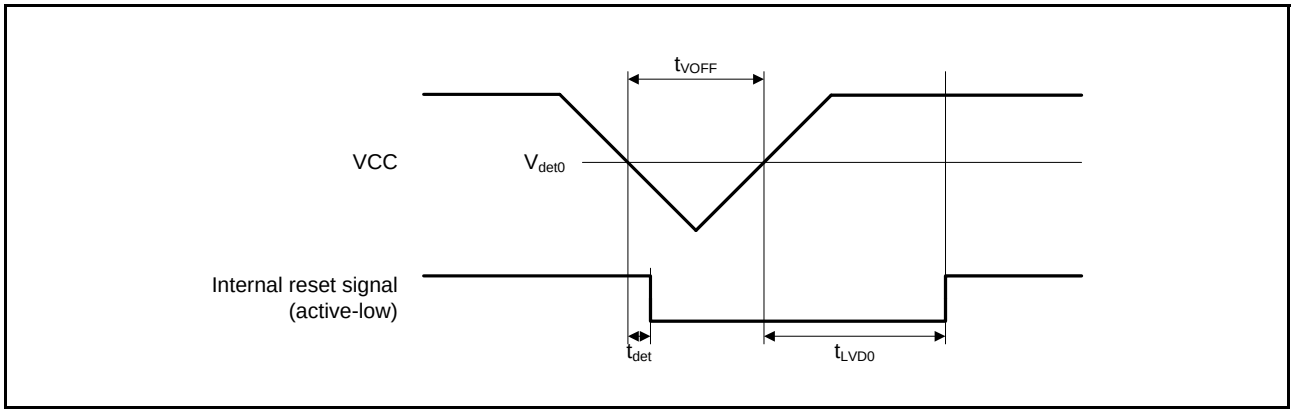


Figure 5.64 Voltage Detection Circuit Timing (V_{det0})

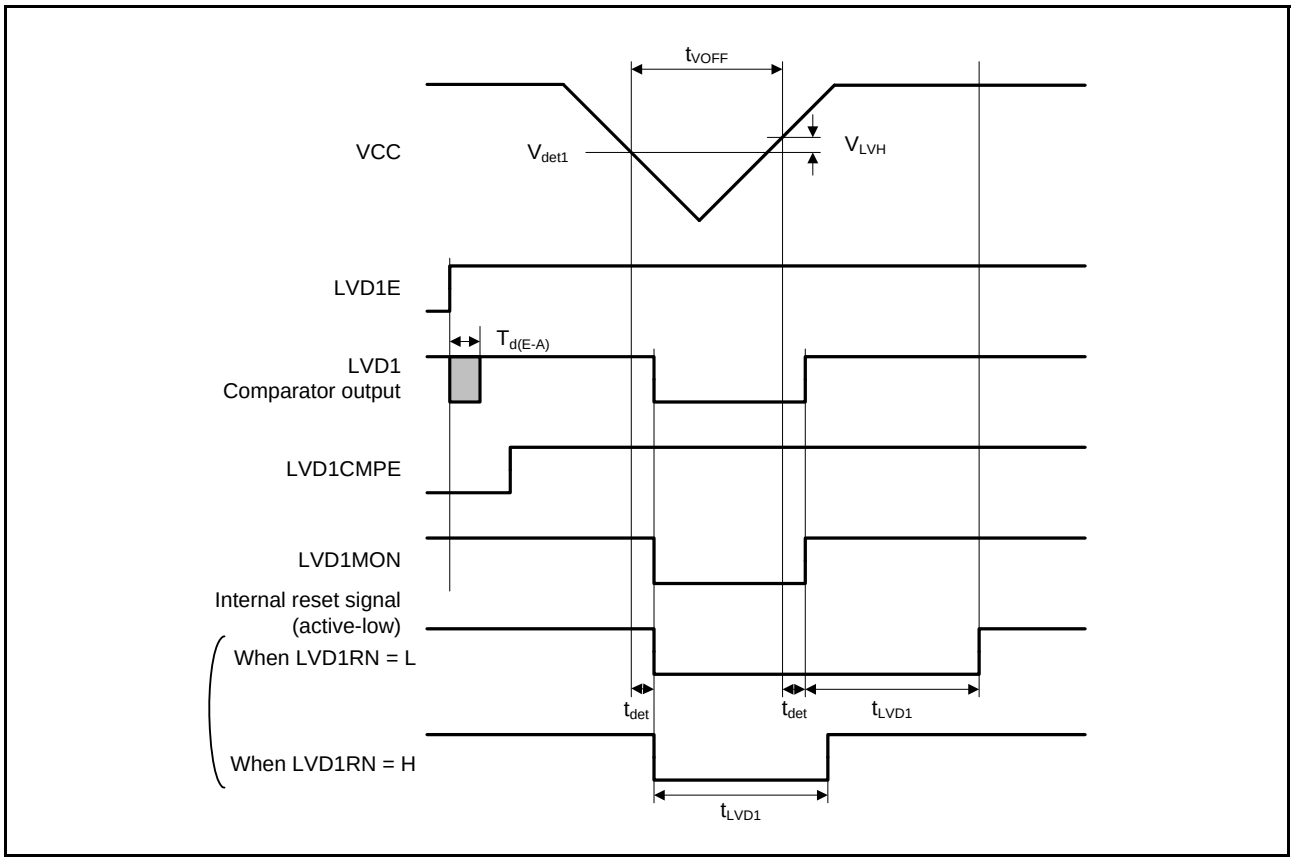


Figure 5.65 Voltage Detection Circuit Timing (V_{det1})

5.12 E^2 Flash Characteristics

Table 5.38 E2 Flash Characteristics (1)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6V, VREFH0 = 2.7V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0V
Temperature range for the programming/erasure operation: $T_a = T_{opr}$

Item	Symbol	min	typ	max	Unit	Condition
Reprogram/erasure cycle*1	N_{DPEC}	100000	—	—	Times	
Data hold time	t_{DDRP}	30*2	—	—	Year	Ta = +85°C

Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 128-byte programming is performed 16 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. The result obtained from the reliability test.

Table 5.39 E^2 Flash Characteristics (2)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
Temperature range for the programming/erasure operation: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz			20 MHz ≤ FCLK ≤ 50 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time $N_{PEC} \leq 100$ times	2 bytes	t_{DP2}	—	0.7	6	—	0.25	2	ms
Programming time $N_{PEC} > 100$ times	2 bytes	t_{DP2}	—	0.7	6	—	0.25	2	ms
Erasure time $N_{PEC} \leq 100$ times	32 bytes	t_{DE32}	—	4	40	—	2	20	ms
Erasure time $N_{PEC} > 100$ times	32 bytes	t_{DE32}	—	7	40	—	4	20	ms
Blank check time	2 bytes	t_{DBC2}	—	—	100	—	—	30	µs
Suspend delay time during programming		t_{DSPD}	—	—	250	—	—	120	µs
First suspend delay time during erasure (in suspend priority mode)		t_{DSESD1}	—	—	250	—	—	120	µs
Second suspend delay time during erasure (in suspend priority mode)		t_{DSESD2}	—	—	500	—	—	300	µs
Suspend delay time during erasure (in erasure priority mode)		t_{DSEED}	—	—	500	—	—	300	µs

Rev.	Date	Description	
		Page	Summary
1.70	Oct 08. 2013	80 to 127	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics	
		131, 132	Table 5.4 DC Characteristics (3), changed, Note. 9, Note. 10, added
		133	Table 5.6 Permissible Output Currents, changed
		139	Table 5.12 Clock Timing (Sub-Clock Related), Note 3, added
		167	Table 5.25 Timing of On-Chip Peripheral Modules (8), added
		175	Figure 5.58 PDC Timing, added
		175	Figure 5.59 PDC Input Clock Characteristic, added
		176	Figure 5.60 PDC Output Clock Characteristic, added
		178	Table 5.27 10-Bit A/D Conversion Characteristics, changed
		179	Table 5.28 12-Bit A/D Conversion Characteristics, changed
		185	Table 5.35 ROM (Flash Memory for Code Storage) Characteristics (1), added
		185	Table 5.36 ROM (Flash Memory for Code Storage) Characteristics (2), changed
		186	Table 5.37 E2 Flash Characteristics (1), added
		186	Table 5.38 E2 Flash Characteristics (2), changed
		Appendix 1.Package Dimensions	
		197	Figure H 64-pin TFLGA (PTLG0064JA-A), added